

Product Features

- 2110 2170 MHz
- 30 dB Gain
- +36 dBm P1dB
- -55 dBc ACLR @ 25 dBm wCDMA linear power
- +12 V Single Supply
- Power Down Mode
- Bias Current Adjustable
- RoHS-compliant flange-mount pkg

Applications

- Final stage amplifiers for repeaters
- Optimized for driver amplifier PA mobile infrastructure

Specifications

Operational Bandwidth

wCDMA ACLR1 @ 25dBm⁽¹⁾

wCDMA ACLR2 @ 25dBm⁽²⁾

Operating Current @ 25 dBm Quiescent Current, Icq

Parameter

Test Frequency

Input Return Loss

Output Return Loss Output P1dB Output IP3

Device Voltage, Vcc Device Voltage, Vpd

Load Stability 3GPP wCDMA sig

3GPP wCDMA s

Pull-down volta

3.

Power Gain

25 °C, V_{cc}=12V, V_{pd}=5V, I_{cq}=820mA, R7=0Ω, 50Ω unmatc

Units

MHz

MHz

dB

dBc

dТ

21

64 N

BW, ±5 MHz offset.

z BW +10 MHz offset

Product Description

The AP502 is a high dynamic range power amplifier in a RoHS-compliant flange-mount package. The multi-stage amplifier module has 30 dB gain, while being able to achieve high performance for UMTS-band applications with +36 dBm of compressed 1dB power. The module has been internally optimized for driver applications provide -55 dBc ACLR at 25 for wCDMA applications. The module can be biased down for current when higher efficiency is required Q

The AP502 uses a high reliability InGaP/GaAs HBT technology and does not require any external manage components. The module operates off a +12V oply and does not requiring any negative biasing voltage active bias allows the amplifier to maintain over temperature. It has the added features allow the added features allow the added features allow the allow the device to have a low thermal resident to ensure the second sec

The AP502 is targeted for use as a contract or final entropy in the distance of the distance o

Trance (4)				
	an (p)	Units	Config1	Config2
	perating Current @ 25 dBm	mA	840	420
	Quies Current, Icq	mA	820	250
\bigcirc	Droff Voltage, Vcc	V	+12	+12
34 20	~z alue	Ω	0	730
S) Z	st Frequency	MHz	2140	2140
S ³ (10	Power Gain	dB	30	27.7
Ň	wCDMA ACLR1 @ 25dBm ⁽²⁾	dBc	-55	-47.5
$\langle \vee \rangle$	Input Return Loss	dB	11	10
	Output Return Loss	dB	5.3	7
<u> </u>	Output P1dB	dBm	+36	+36
A40	Output IP3	dBm	+52	+50
920				

TriQuint

SEMICONDUC

Function

RF Output

Vcc

Vpd

RF Input

Ground

Functional Dia

4. Configuration 1 has the module biased in Class AB and is detailed on page 2 of the datasheet. Performance is shown at 25 °C, Vcc=12V, Vpd=5V, Icq=820mA, R7=0Ω, 50Ω unmatched fixture. Configuration 2 has the module biased in near Class B and is detailed on page 3 of the datasheet. Performance is shown at 25 °C, Vcc=12V, Vpd=5V, Icq=250mA, R7=730Ω, 50Ω unmed fixture.

Absolut Max m Rating Paramete Rating

r al all gites	Γαιτιγ
Operation ase T operature	-40 to +85 °C
Sto mper zure	-55 to +150 °C
R Pow (ntinuous)	+15 dBm

Ordering Information

Part No.	Description
AP502	UMTS-band 4W HBT Amplifier Module
AP502-PCB	Fully-Assembled Evaluation Board (Class AB configuration, Icq=820mA)

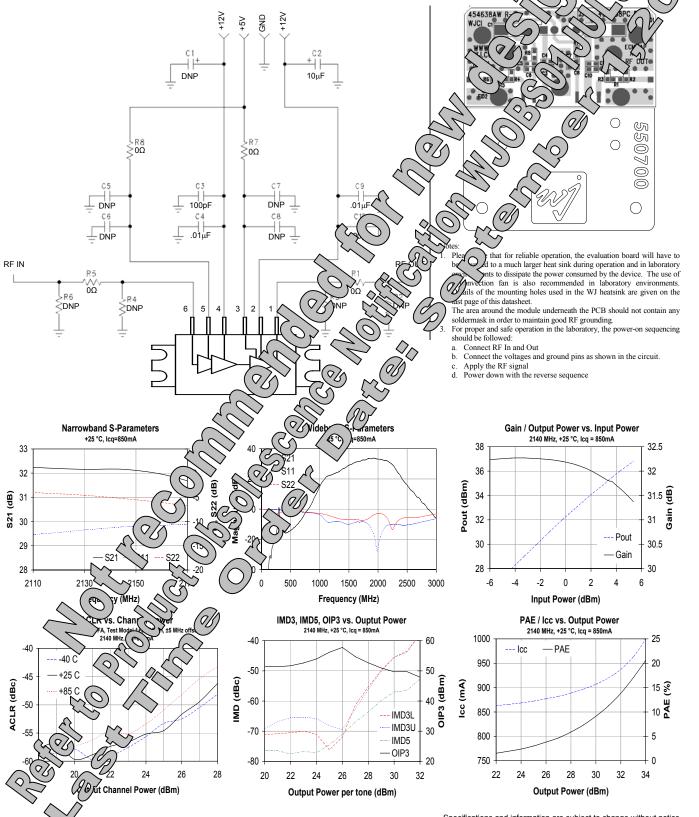
n of this Jabove any of these parameters may cause permanent damage.





Performance Graphs – Class AB Configuration (AP502-I

The AP502-PCB and AP502 module is configured for Class AB by default. The resistor – R7 – which s the amplifier is set at 0 Ω in this configuration. Increasing that value will decrease the quiescent and amplifier module, as described on the next page.

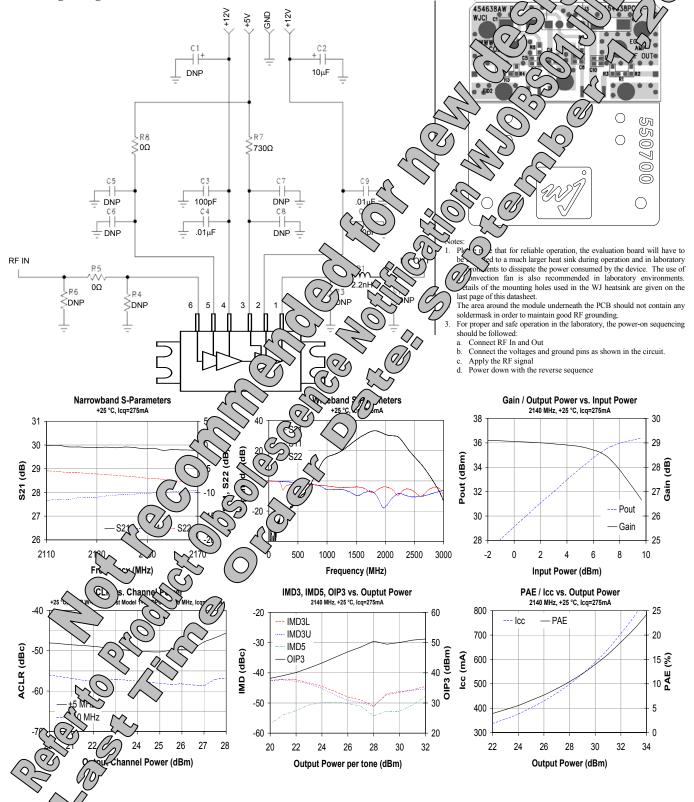






Performance Graphs – Class B Configuration

The AP502 can be adjusted to operate at lower current biasing levels by modifying the R7 resistor at prove the performance. The configuration shown on this page has the AP502 operating with Icq = 250 mA (Ie to make a dBn Output L-C matching components have been added externally on the circuit to optimize the amplifier of CPR to make this biasing configuration.







MTTF Calculation

The MTTF of the AP502 can be calculated by first determining how much power is being dissipated by the amplifier module. Because the device's intended application is to be a power amplifier pre-driver or final stage output amplifier, the output RF power of the amplifier will help lower the overall power dissipation. In addition, the amplifier can be biased with different quiescent currents, so the calculation of the MTTF is custom to each application.

The power dissipation of the device can be calculated with the following equation:

$$\begin{split} P_{diss} &= V_{cc} * I_{cc} - (Output RF Power - Input RF Power), \\ V_{cc} &= Operating \ supply \ voltage = 12V \\ I_{cc} &= Operating \ current \\ \{The RF \ power \ is \ converted \ to \ Watts\} \end{split}$$

While the maximum recommended case temperature on the datasheet is listed at 85 °C, it is suggested that customers maintain an MTTF above 1 million hours. This would convert to a derating curve for maximum case temperature power dissipation as shown in the plot below.

To calculate the MTTF for the dule, the netice temperature needs to be determ to This the calculated with the module's period the the netice resistance value, and the case determined to ratio of

 $T_{j} = P_{diss} * R_{th} + T_{se}$ $T_{j} = Junction$ $P_{diss} = Power$ $T_{th} = Therval resistance C/W$ $T_{case} = C$ $T_{case} = C$ $T_{case} = C$

From a num stand, he F can be calculated using the section

MTTP A* $e^{(Lak'T)}$ A = Pre-expected on the formula Formula

 $= 0.017 \times 10^{\circ} \text{ eV/ K}$ $= 0.017 \times 10^{\circ} \text{ eV/ K}$ $= 0.017 \times 10^{\circ} \text{ eV/ K}$

MTTF can be shown in the plot

